

## Features

- Serial Peripheral Interface (SPI) Compatible
- Supports SPI Modes 0 (0,0) and 3 (1,1)
  - Datasheet Describes Mode 0 Operation
- Low-voltage and Standard-voltage Operation
  - 1.8 ( $V_{CC} = 1.8V$  to 5.5V)
- 20MHz Clock Rate (5V)
- 32-byte Page Mode
- Block Write Protection
  - Protect 1/4, 1/2, or Entire Array
- Write Protect (WP) Pin and Write Disable Instructions for Both Hardware and Software Data Protection
- Self-timed Write Cycle (5ms max)
- High Reliability
  - Endurance: One Million Write Cycles
  - Data Retention: 100 Years
- Green (Pb/Halide-free/RoHS Compliant) Packaging Options
- Die Sales: Wafer Form, Tape and Reel, and Bumped Wafers

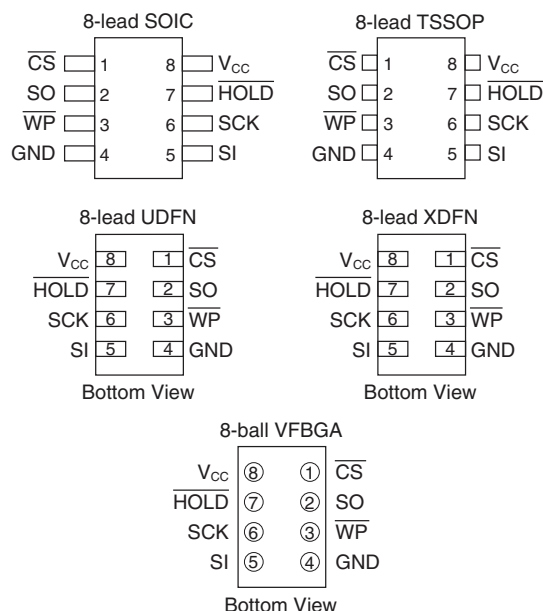
## Description

The Atmel® AT25080B/160B provides 8192/16384 bits of serial electrically-erasable programmable read-only memory (EEPROM) organized as 1024/2048 words of 8 bits each. The device is optimized for use in many industrial and commercial applications where low-power and low-voltage operation are essential. The AT25080B/160B is available in space-saving 8-lead JEDEC SOIC, 8-lead UDFN, 8-lead TSSOP, 8-lead XDFN, and 8-ball VFBGA packages.

The AT25080B/160B is enabled through the Chip Select pin ( $\overline{CS}$ ) and accessed via a three-wire interface consisting of Serial Data Input (SI), Serial Data Output (SO), and Serial Clock (SCK). All programming cycles are completely self-timed, and no separate erase cycle is required before write.

**Figure 1.** Pin Configuration

Pin Name	Function
$\overline{CS}$	Chip Select
SCK	Serial Data Clock
SI	Serial Data Input
SO	Serial Data Output
GND	Ground
$V_{CC}$	Power Supply
$\overline{WP}$	Write Protect
$\overline{HOLD}$	Suspends Serial Input



## SPI Serial EEPROMs 8K (1024 x 8) 16K (2048 x 8)

Atmel AT25080B  
Atmel AT25160B



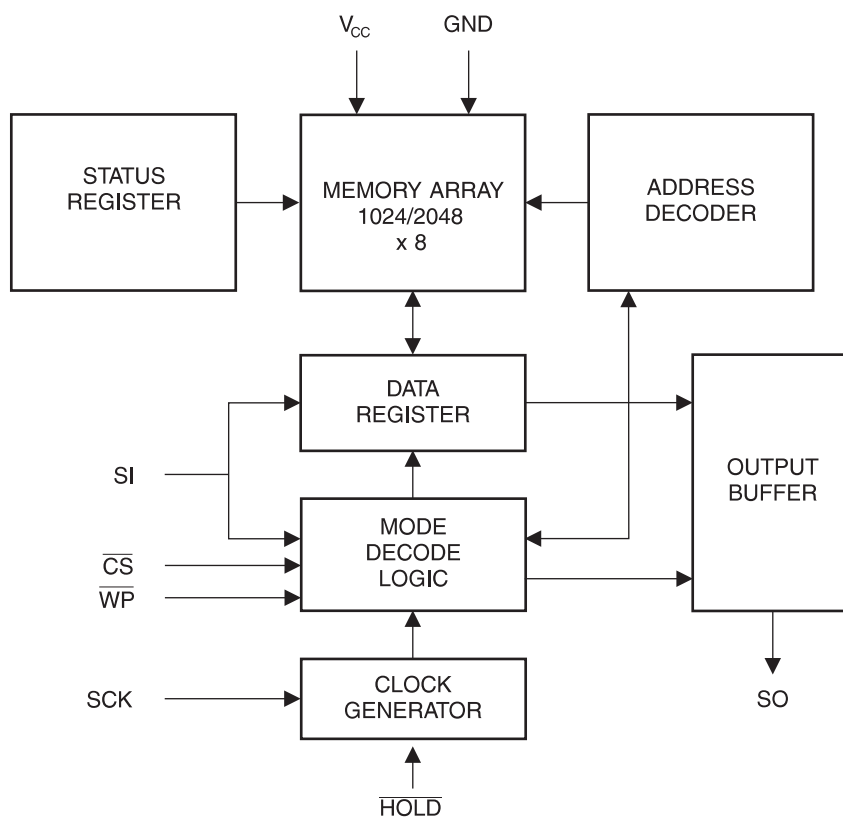
Block write protection is enabled by programming the status register with one of four blocks of write protection. Separate program enable and program disable instructions are provided for additional data protection. Hardware data protection is provided via the  $\overline{WP}$  pin to protect against inadvertent write attempts to the status register. The  $\overline{HOLD}$  pin may be used to suspend any serial communication without resetting the serial sequence.

## 2. Absolute Maximum Ratings\*

Operating Temperature .....	-55°C to +125°C
Storage Temperature .....	-65°C to +150°C
Voltage on Any Pin with Respect to Ground.....	-1.0V to +7.0V
Maximum Operating Voltage.....	6.25V
DC Output Current .....	5.0mA

**\*NOTICE:** Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**Figure 2-1.** Block Diagram



**Table 2-1.** Pin Capacitance<sup>(1)</sup>

 Applicable over recommended operating range from  $T_A = 25^\circ\text{C}$ ,  $f = 1.0\text{MHz}$ ,  $V_{CC} = +5.0\text{V}$  (unless otherwise noted)

Symbol	Test Conditions	Max	Units	Conditions
$C_{OUT}$	Output Capacitance (SO)	8	pF	$V_{OUT} = 0\text{V}$
$C_{IN}$	Input Capacitance ( $\overline{CS}$ , SCK, SI, WP, $\overline{HOLD}$ )	6	pF	$V_{IN} = 0\text{V}$

Note: 1. This parameter is characterized and is not 100% tested

**Table 2-2.** DC Characteristics

 Applicable over recommended operating range from:  $T_{AI} = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ,  $V_{CC} = +1.8\text{V}$  to  $+5.5\text{V}$  (unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Typ	Max	Units
$V_{CC1}$	Supply Voltage		1.8		5.5	V
$V_{CC2}$	Supply Voltage		2.5		5.5	V
$V_{CC3}$	Supply Voltage		4.5		5.5	V
$I_{CC1}$	Supply Current	$V_{CC} = 5.0\text{V}$ at 20MHz, SO = Open, Read		7.5	10.0	mA
$I_{CC2}$	Supply Current	$V_{CC} = 5.0\text{V}$ at 20MHz, SO = Open, Read, Write		4.0	10.0	mA
$I_{CC3}$	Supply Current	$V_{CC} = 5.0\text{V}$ at 5MHz, SO = Open, Read, Write		4.0	6.0	mA
$I_{SB1}$	Standby Current	$V_{CC} = 1.8\text{V}$ , $\overline{CS} = V_{CC}$		< 0.1	6.0 <sup>(2)</sup>	$\mu\text{A}$
$I_{SB2}$	Standby Current	$V_{CC} = 2.5\text{V}$ , $\overline{CS} = V_{CC}$		0.3	7.0 <sup>(2)</sup>	$\mu\text{A}$
$I_{SB3}$	Standby Current	$V_{CC} = 5.0\text{V}$ , $\overline{CS} = V_{CC}$		2.0	10.0 <sup>(2)</sup>	$\mu\text{A}$
$I_{IL}$	Input Leakage	$V_{IN} = 0\text{V}$ to $V_{CC}$	-3.0		3.0	$\mu\text{A}$
$I_{OL}$	Output Leakage	$V_{IN} = 0\text{V}$ to $V_{CC}$ , $T_{AC} = 0^\circ\text{C}$ to $70^\circ\text{C}$	-3.0		3.0	$\mu\text{A}$
$V_{IL}^{(1)}$	Input Low-voltage		-0.6		$V_{CC} \times 0.3$	V
$V_{IH}^{(1)}$	Input High-voltage		$V_{CC} \times 0.7$		$V_{CC} + 0.5$	V
$V_{OL1}$	Output Low-voltage	$3.6\text{V} \leq V_{CC} \leq 5.5\text{V}$	$I_{OL} = 3.0\text{mA}$		0.4	V
$V_{OH1}$	Output High-voltage		$I_{OH} = -1.6\text{mA}$	$V_{CC} - 0.8$		V
$V_{OL2}$	Output Low-voltage	$1.8\text{V} \leq V_{CC} \leq 3.6\text{V}$	$I_{OL} = 0.15\text{mA}$		0.2	V
$V_{OH2}$	Output High-voltage		$I_{OH} = -100\mu\text{A}$	$V_{CC} - 0.2$		V

 Notes: 1.  $V_{IL}$  min and  $V_{IH}$  max are reference only and are not tested

 2. Worst case measured at  $85^\circ\text{C}$

**Table 2-3.** AC Characteristics

Applicable over recommended operating range from  $T_{AI} = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{CC} = \text{As Specified}$ ,  
 $CL = 1$  TTL Gate and 30pF (unless otherwise noted)

Symbol	Parameter	Voltage	Min	Max	Units
$f_{SCK}$	SCK Clock Frequency	4.5–5.5 2.5–5.5 1.8–5.5	0 0 0	20 10 5	MHz
$t_{RI}$	Input Rise Time	4.5–5.5 2.5–5.5 1.8–5.5		2 2 2	$\mu\text{s}$
$t_{FI}$	Input Fall Time	4.5–5.5 2.5–5.5 1.8–5.5		2 2 2	$\mu\text{s}$
$t_{WH}$	SCK High Time	4.5–5.5 2.5–5.5 1.8–5.5	20 40 80		ns
$t_{WL}$	SCK Low Time	4.5–5.5 2.5–5.5 1.8–5.5	20 40 80		ns
$t_{CS}$	$\overline{CS}$ High Time	4.5–5.5 2.5–5.5 1.8–5.5	25 50 100		ns
$t_{CSS}$	$\overline{CS}$ Setup Time	4.5–5.5 2.5–5.5 1.8–5.5	25 50 100		ns
$t_{CSH}$	$\overline{CS}$ Hold Time	4.5–5.5 2.5–5.5 1.8–5.5	25 50 100		ns
$t_{SU}$	Data In Setup Time	4.5–5.5 2.5–5.5 1.8–5.5	5 10 20		ns
$t_H$	Data In Hold Time	4.5–5.5 2.5–5.5 1.8–5.5	5 10 20		ns
$t_{HD}$	$\overline{HOLD}$ Setup Time	4.5–5.5 2.5–5.5 1.8–5.5	5 10 20		
$t_{CD}$	$\overline{HOLD}$ Hold Time	4.5–5.5 2.5–5.5 1.8–5.5	5 10 20		ns
$t_V$	Output Valid	4.5–5.5 2.5–5.5 1.8–5.5	0 0 0	20 40 80	ns
$t_{HO}$	Output Hold Time	4.5–5.5 2.5–5.5 1.8–5.5	0 0 0		ns

**Table 2-3.** AC Characteristics (Continued)

Applicable over recommended operating range from  $T_{AI} = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{CC} = \text{As Specified}$ ,  
 $CL = 1$  TTL Gate and 30pF (unless otherwise noted)

Symbol	Parameter	Voltage	Min	Max	Units
$t_{LZ}$	$\overline{\text{HOLD}}$ to Output Low Z	4.5–5.5	0	25	ns
		2.5–5.5	0	50	
		1.8–5.5	0	100	
$t_{HZ}$	$\overline{\text{HOLD}}$ to Output High Z	4.5–5.5		40	ns
		2.5–5.5		80	
		1.8–5.5		200	
$t_{DIS}$	Output Disable Time	4.5–5.5		40	ns
		2.5–5.5		80	
		1.8–5.5		200	
$t_{WC}$	Write Cycle Time	4.5–5.5		5	ms
		2.5–5.5		5	
		1.8–5.5		5	
Endurance <sup>(1)</sup>	3.3V, 25°C, Page Mode		1M		Write Cycles

Note: 1. This parameter is characterized and is not 100% tested

### 3. Serial Interface Description

**MASTER:** The device that generates the serial clock.

**SLAVE:** Because the Serial Clock pin (SCK) is always an input, the AT25080B/160B always operates as a slave.

**TRANSMITTER/RECEIVER:** The AT25080B/160B has separate pins designated for data transmission (SO) and reception (SI).

**MSB:** The Most Significant Bit (MSB) is the first bit transmitted and received.

**SERIAL OP-CODE:** After the device is selected with  $\overline{\text{CS}}$  going low, the first byte will be received. This byte contains the op-code that defines the operations to be performed.

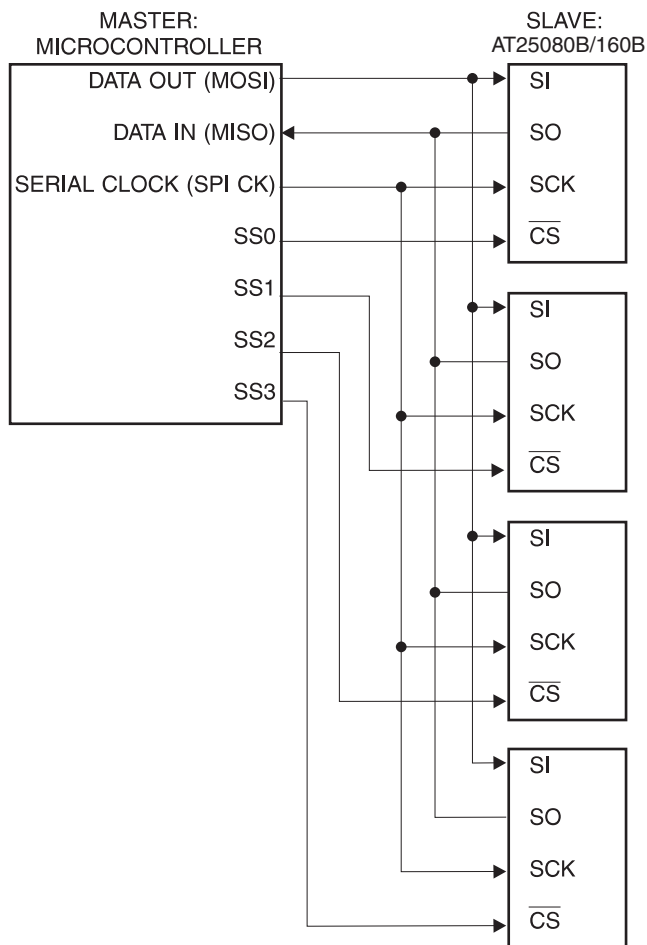
**INVALID OP-CODE:** If an invalid op-code is received, no data will be shifted into the AT25080B/160B, and the serial output pin (SO) will remain in a high impedance state until the falling edge of  $\overline{\text{CS}}$  is detected again. This will reinitialize the serial communication.

**CHIP SELECT:** The AT25080B/160B is selected when the  $\overline{\text{CS}}$  pin is low. When the device is not selected, data will not be accepted via the SI pin, and the serial output pin (SO) will remain in a high impedance state.

**HOLD:** The  $\overline{\text{HOLD}}$  pin is used in conjunction with the  $\overline{\text{CS}}$  pin to select the AT25080B/160B. When the device is selected and a serial sequence is underway,  $\overline{\text{HOLD}}$  can be used to pause the serial communication with the master device without resetting the serial sequence. To pause, the  $\overline{\text{HOLD}}$  pin must be brought low while the SCK pin is low. To resume serial communication, the  $\overline{\text{HOLD}}$  pin is brought high while the SCK pin is low (SCK may still toggle during  $\overline{\text{HOLD}}$ ). Inputs to the SI pin will be ignored while the SO pin is in the high impedance state.

**WRITE PROTECT:** The write protect pin ( $\overline{\text{WP}}$ ) will allow normal read/write operations when held high. When the WP pin is brought low and WPEN bit is “1”, all write operations to the status register are inhibited.  $\overline{\text{WP}}$  going low while  $\overline{\text{CS}}$  is still low will interrupt a write to the status register. If the internal write cycle has already been initiated,  $\overline{\text{WP}}$  going low will have no effect on any write operation to the status register. The  $\overline{\text{WP}}$  pin function is blocked when the WPEN bit in the status register is “0”. This will allow the user to install the AT25080B/160B in a system with the  $\overline{\text{WP}}$  pin tied to ground and still be able to write to the status register. All  $\overline{\text{WP}}$  pin functions are enabled when the WPEN bit is set to “1”.

**Figure 3-1. SPI Serial Interface**



## 4. Functional Description

The AT25080B/160B is designed to interface directly with the synchronous serial peripheral interface (SPI) of the 6805 and 68HC11 series of microcontrollers.

The AT25080B/160B utilizes an 8-bit instruction register. The list of instructions and their operation codes are contained in [Table 3-1](#). All instructions, addresses, and data are transferred with the MSB first and start with a high-to-low CS transition.

**Table 4-1.** Instruction Set for the AT25080B/160B

Instruction Name	Instruction Format	Operation
WREN	0000 X110	Set Write Enable Latch
WRDI	0000 X100	Reset Write Enable Latch
RDSR	0000 X101	Read Status Register
WRSR	0000 X001	Write Status Register
READ	0000 X011	Read Data from Memory Array
WRITE	0000 X010	Write Data to Memory Array

**WRITE ENABLE (WREN):** The device will power up in the write disable state when  $V_{CC}$  is applied. All programming instructions must therefore be preceded by a Write Enable instruction.

**WRITE DISABLE (WRDI):** To protect the device against inadvertent writes, the Write Disable instruction disables all programming modes. The WRDI instruction is independent of the status of the  $\overline{WP}$  pin.

**READ STATUS REGISTER (RDSR):** The Read Status Register instruction provides access to the status register. The READY/BUSY and Write Enable status of the device can be determined by the RDSR instruction. Similarly, the Block Write Protection Bits indicate the extent of protection employed. These bits are set by using the WRSR instruction.

**Table 4-2.** Status Register Format

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
WPEN	X	X	X	BP1	BP0	WEN	$\overline{RDY}$

**Table 4-3.** Read Status Register Bit Definition

Bit	Definition
Bit 0 ( $\overline{RDY}$ )	Bit 0 = "0" ( $\overline{RDY}$ ) indicates the device is READY. Bit 0 = "1" indicates the write cycle is in progress
Bit 1 (WEN)	Bit 1 = "0" indicates the device is not WRITE ENABLED. Bit 1 = "1" indicates the device is write enabled
Bit 2 (BP0)	See <a href="#">Table 3-4 on page 8</a>
Bit 3 (BP1)	See <a href="#">Table 3-4 on page 8</a>
Bits 4–6 are "0"s when device is not in an internal write cycle	
Bit 7 (WPEN)	See <a href="#">Table 3-5 on page 8</a>
Bits 0–7 are "1"s during an internal write cycle	

**WRITE STATUS REGISTER (WRSR):** The WRSR instruction allows the user to select one of four levels of protection. The AT25080B/160B is divided into four array segments. One-quarter, one-half, or all of the memory segments can be protected. Any of the data within any selected segment will therefore be read only. The block write protection levels and corresponding status register control bits are shown in Table 3-4.

The three bits BP0, BP1, and WPEN are nonvolatile cells that have the same properties and functions as the regular memory cells (e.g., WREN,  $t_{WC}$ , RDSR).

**Table 4-4.** Block Write Protect Bits

Level	Status Register Bits		Array Addresses Protected	
	BP1	BP0	AT25080B	AT25160B
0	0	0	None	None
1(1/4)	0	1	0300–03FF	0600–07FF
2(1/2)	1	0	0200–03FF	0400–07FF
3(All)	1	1	0000–03FF	0000–07FF

The WRSR instruction also allows the user to enable or disable the write protect ( $\overline{WP}$ ) pin through the use of the Write Protect Enable (WPEN) bit. Hardware write protection is enabled when the  $\overline{WP}$  pin is low and the WPEN bit is “1”. Hardware write protection is disabled when either the  $\overline{WP}$  pin is high or the WPEN bit is “0”. When the device is hardware write protected, writes to the status register, including the block protect bits and the WPEN bit, and the block-protected sections in the memory array are disabled. Writes are only allowed to sections of the memory that are not block-protected.

Note: When the WPEN bit is hardware write protected, it cannot be changed back to “0” as long as the  $\overline{WP}$  pin is held low.

**Table 4-5.** WPEN Operation

WPEN	$\overline{WP}$	WEN	Protected Blocks	Unprotected Blocks	Status Register
0	X	0	Protected	Protected	Protected
0	X	1	Protected	Writeable	Writeable
1	Low	0	Protected	Protected	Protected
1	Low	1	Protected	Writeable	Protected
X	High	0	Protected	Protected	Protected
X	High	1	Protected	Writeable	Writeable

**READ SEQUENCE (READ):** Reading the AT25080B/160B via the Serial Output (SO) pin requires the following sequence. After the  $\overline{CS}$  line is pulled low to select a device, the read op-code is transmitted via the SI line followed by the byte address to be read (A15–A0, see Table 3-6). Upon completion, any data on the SI line will be ignored. The data (D7–D0) at the specified address is then shifted out onto the SO line. If only one byte is to be read, the  $\overline{CS}$  line should be driven high after the data comes out. The read sequence can be continued since the byte address is automatically incremented and data will continue to be shifted out. When the highest address is reached, the address counter will roll over to the lowest address allowing the entire memory to be read in one continuous read cycle.



**WRITE SEQUENCE (WRITE):** In order to program the AT25080B/160B, two separate instructions must be executed. First, the device **must be write enabled** via the WREN instruction. Then a write (WRITE) instruction may be executed. Also, the address of the memory location(s) to be programmed must be outside the protected address field location selected by the block write protection level. During an internal write cycle, all commands will be ignored except the RDSR instruction.

A write instruction requires the following sequence. After the  $\overline{CS}$  line is pulled low to select the device, the WRITE op-code is transmitted via the SI line followed by the byte address (A15–A0) and the data (D7–D0) to be programmed (see Table 3-6). Programming will start after the  $\overline{CS}$  pin is brought high. The low-to-high transition of the  $\overline{CS}$  pin must occur during the SCK low-time immediately after clocking in the D0 (LSB) data bit.

The READY/BUSY status of the device can be determined by initiating a read status register (RDSR) instruction. If Bit 0 = “1”, the write cycle is still in progress. If Bit 0 = “0”, the write cycle has ended. Only the RDSR instruction is enabled during the write programming cycle.

The AT25080B/160B is capable of a 32-byte page write operation. After each byte of data is received, the five low-order address bits are internally incremented by one; the high-order bits of the address will remain constant. If more than 32 bytes of data are transmitted, the address counter will roll over and the previously written data will be overwritten. The AT25080B/160B is automatically returned to the write disable state at the completion of a write cycle.

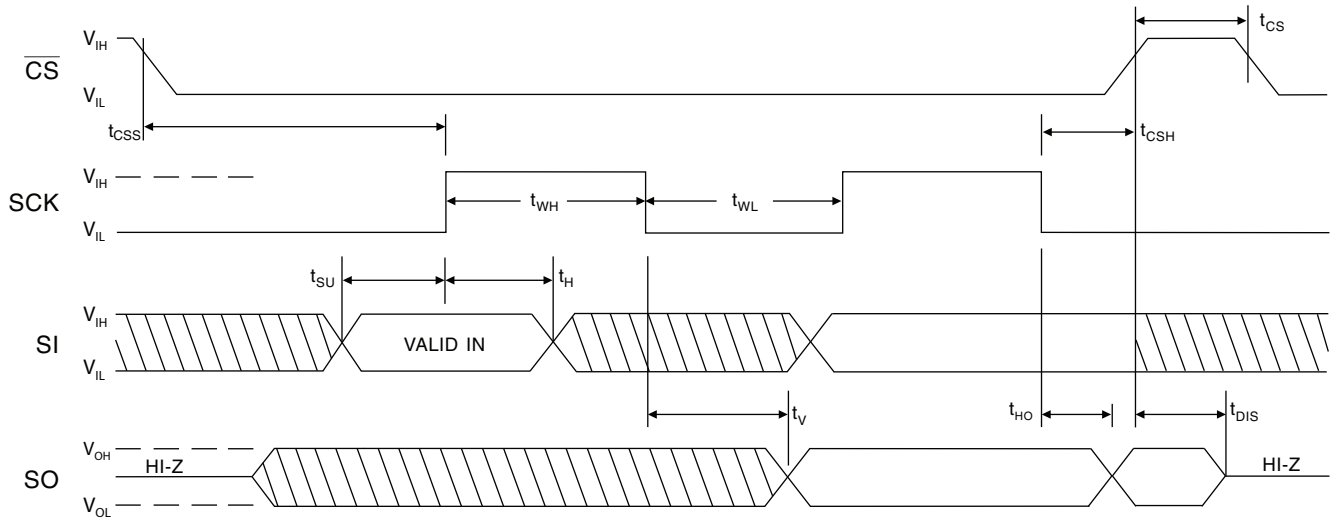
Note: If the device is not write-enabled (WREN), the device will ignore the write instruction and will return to the standby state, when  $\overline{CS}$  is brought high. A new  $\overline{CS}$  falling edge is required to reinitiate the serial communication.

**Table 4-6.** Address Key

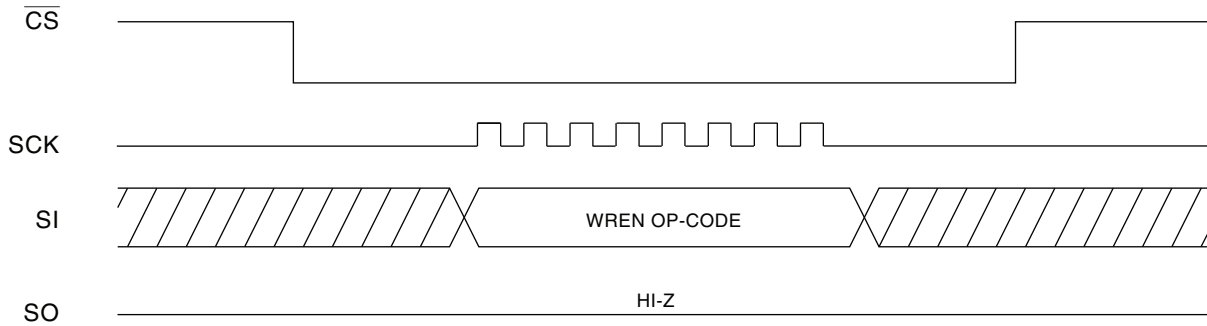
Address	AT25080B	AT25160B
$A_N$	$A_9-A_0$	$A_{10}-A_0$
Don't Care Bits	$A_{15}-A_{10}$	$A_{15}-A_{11}$

## 5. Timing Diagrams

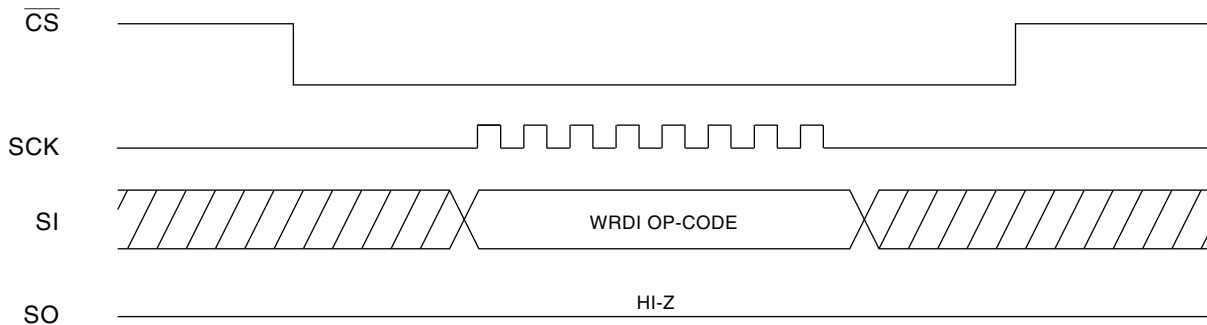
**Figure 5-1.** Synchronous Data Timing (for Mode 0)



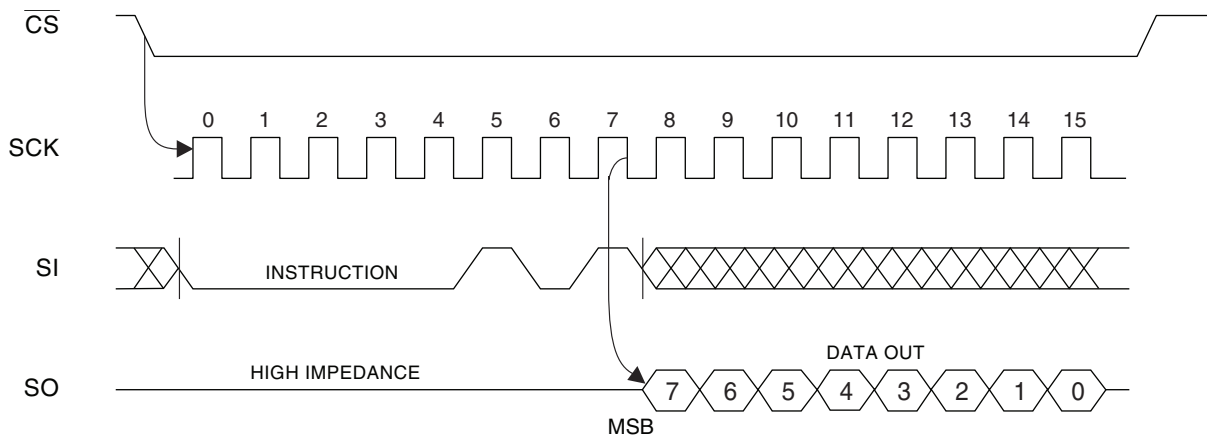
**Figure 5-2.** WREN Timing



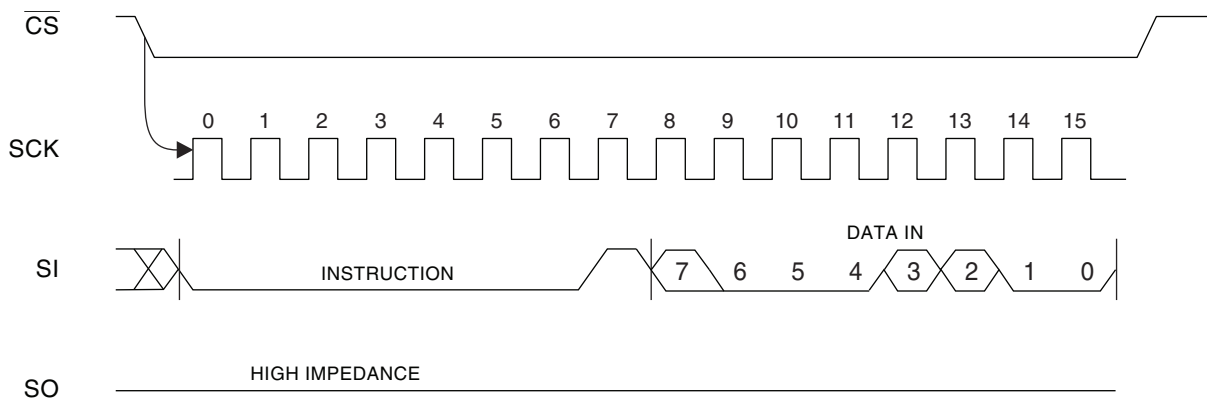
**Figure 5-3.** WRDI Timing



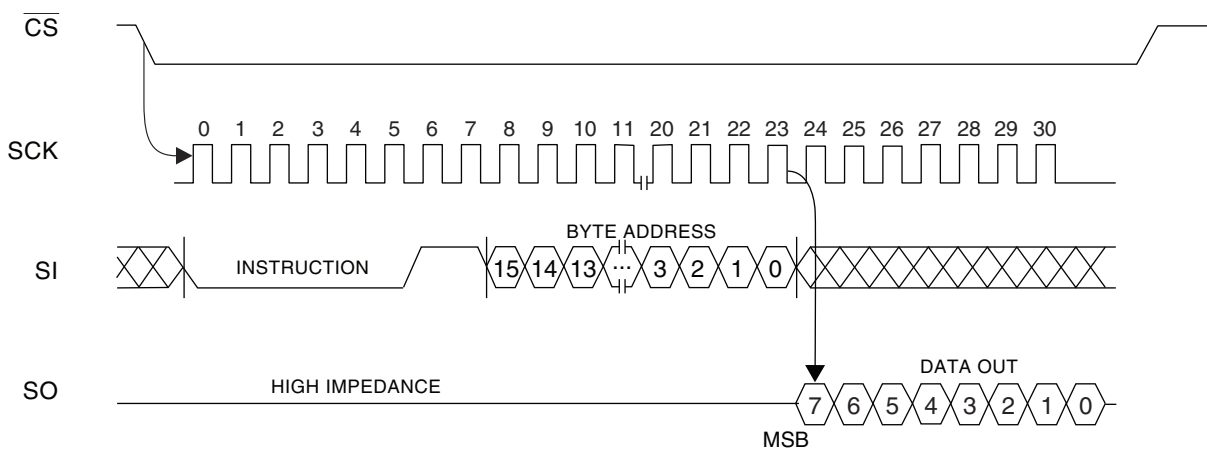
**Figure 5-4. RDSR Timing**



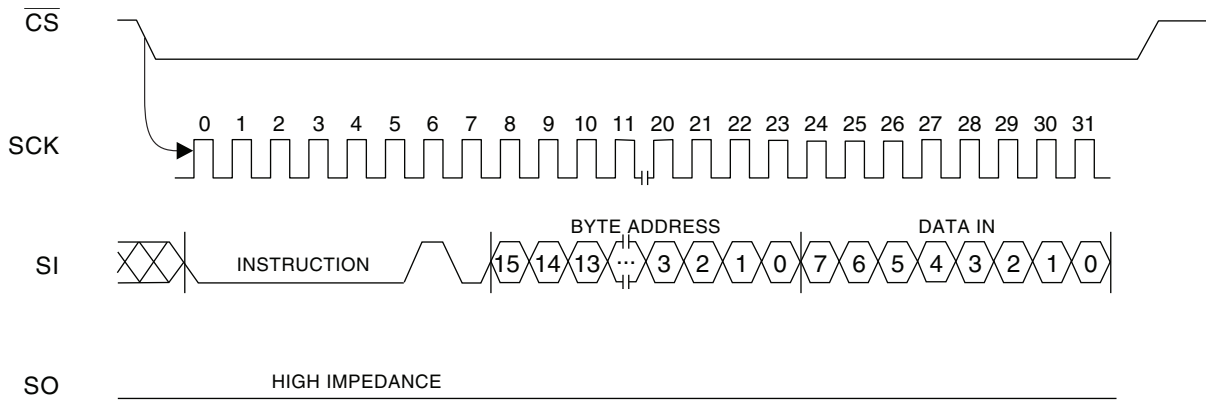
**Figure 5-5. WRSR Timing**



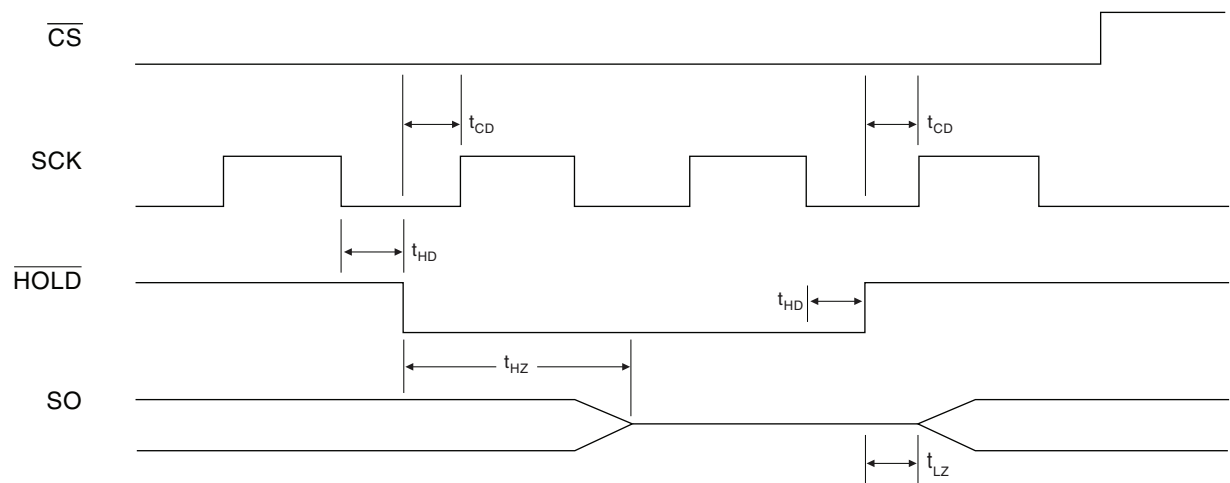
**Figure 5-6. READ Timing**



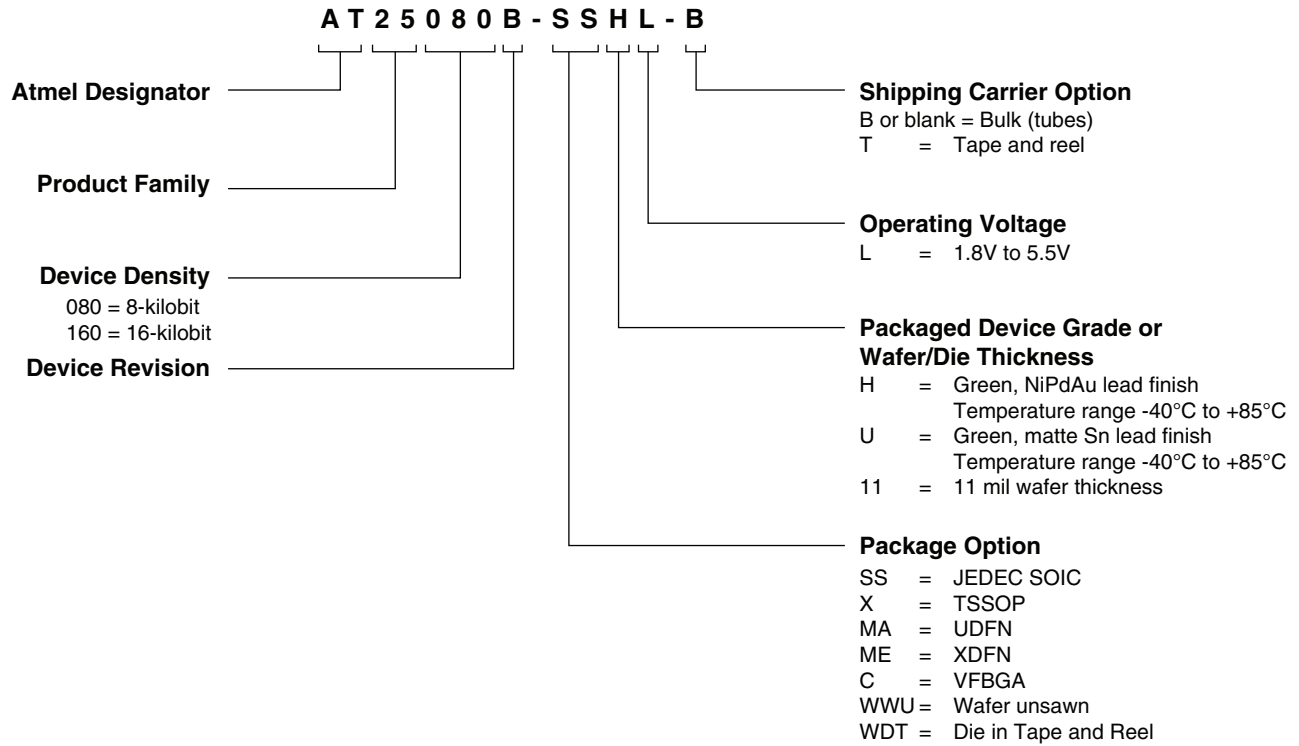
**Figure 5-7. WRITE Timing**



**Figure 5-8.  $\overline{\text{HOLD}}$  Timing**



## 6. Ordering Code Detail



## 7. Part Markings

### 7.1 AT25080B

#### AT25080B-SSHL

Top Mark

Seal Year				Seal Week				@ = Country of Ass'y			
Y = SEAL YEAR				WW = SEAL WEEK							
6: 2006	0: 2010	02 = Week 2									
7: 2007	1: 2011	04 = Week 4									
8: 2008	2: 2012	:: : :::: :									
9: 2009	3: 2013	:: : :::: :									
		50 = Week 50									
		52 = Week 52									

\* LOT NUMBER

PIN 1 INDICATOR (DOT)

#### AT25080B-XHL

Top Mark

PIN 1 INDICATOR (DOT)				@ = Country of Ass'y				WW = SEAL WEEK			
Y = SEAL YEAR				WW = SEAL WEEK							
8: 2008	2: 2012	02 = Week 2									
9: 2009	3: 2013	04 = Week 4									
0: 2010	4: 2014	:: : :::: :									
1: 2011	5: 2015	:: : :::: :									
		50 = Week 50									
		52 = Week 52									

ATMEL LOT NUMBER

#### AT25080B-MAHL

Top Mark

Y = YEAR OF ASSEMBLY				@ = Country of Ass'y				XX= ATMEL LOT NUMBER TO COORESPOND			
WITH TRACE CODE LOG BOOK				(e.g. XX = AA, AB, AC, ... AX, AY AZ)				Y = SEAL YEAR			
6: 2006	0: 2010										
7: 2007	1: 2011										
8: 2008	2: 2012										
9: 2009	3: 2013										

PIN 1 INDICATOR (DOT)

## AT25080B-MEHL

Top Mark

```

|---|---|---|
  5   8   B
|---|---|---|
  Y   X   X
|---|---|---|
  *
  |
PIN 1 INDICATOR (DOT)

```

Y = YEAR OF ASSEMBLY  
 XX= ATMEL LOT NUMBER TO COORESPOND  
 WITH TRACE CODE LOG BOOK  
 (e.g. XX = AA, AB, AC, ... AX, AY AZ)  
 Y = SEAL YEAR

6: 2006	0: 2010
7: 2007	1: 2011
8: 2008	2: 2012
9: 2009	3: 2013

## AT25080B-CUL

Top Mark

```

|---|---|---|---|
  5   8   B   U
|---|---|---|---|
  B   Y   M   X   X
|---|---|---|---|
  * <-- PIN 1 INDICATOR

```

B = Country of Origin  
 Y = One Digit Year Code  
 M = One Digit Month Code  
 XX= TRACE CODE (ATMEL LOT NUMBER TO  
 COORESPOND WITH TRACE CODE LOG BOOK)  
 (e.g. XX = AA, AB, AC, ... YZ, ZZ)

Y = ONE DIGIT YEAR CODE	M = SEAL MONTH
4: 2004	7: 2007
5: 2005	8: 2008
6: 2006	9: 2009
	(USE ALPHA DESIGNATOR A-L)
	A = JANUARY
	B = FEBRUARY
	" " " " " " " " " "
	J = OCTOBER
	K = NOVEMBER
	L = DECEMBER

## 7.2 AT25160B

### AT25160B-SSHL

Top Mark

Seal Year				Seal Week			
---	---	---	---	---	---	---	---
A	T	M	L	H	Y	W	W
---	---	---	---	---	---	---	---
5	A	B			L		@
---	---	---	---	---	---	---	---
* LOT NUMBER							
---	---	---	---	---	---	---	---
PIN 1 INDICATOR (DOT)							

@ = Country of Ass'y  
Y = SEAL YEAR  
WW = SEAL WEEK

6: 2006	0: 2010	02 = Week 2
7: 2007	1: 2011	04 = Week 4
8: 2008	2: 2012	:: : :::: :
9: 2009	3: 2013	:: : :::: ::
		50 = Week 50
		52 = Week 52

### AT25160B-XHL

Top Mark

PIN 1 INDICATOR (DOT)			
*  --- --- --- --- --- ---			
A T H Y W W			
--- --- --- --- --- ---			
5 A B L @			
--- --- --- --- --- ---			
ATMEL LOT NUMBER			
--- --- --- --- --- ---			

@ = Country of Ass'y  
Y = SEAL YEAR  
WW = SEAL WEEK

8: 2008	2: 2012	02 = Week 2
9: 2009	3: 2013	04 = Week 4
0: 2010	4: 2014	:: : :::: :
1: 2011	5: 2015	:: : :::: ::
		50 = Week 50
		52 = Week 52

### AT25160B-MAHL

Top Mark

---	---	---
5	A	B
---	---	---
H	L	@
---	---	---
Y	X	X
---	---	---
*		
PIN 1 INDICATOR (DOT)		

Y = YEAR OF ASSEMBLY  
@ = Country of Ass'y  
XX= ATMEL LOT NUMBER TO COORESPOND WITH TRACE CODE LOG BOOK  
(e.g. XX = AA, AB, AC, ... AX, AY AZ)  
Y = SEAL YEAR

6: 2006	0: 2010
7: 2007	1: 2011
8: 2008	2: 2012
9: 2009	3: 2013



## AT25160B-MEHL

Top Mark

```

|---|---|---|
  5   A   B
|---|---|---|
  Y   X   X
|---|---|---|
  *
  |
PIN 1 INDICATOR (DOT)

```

Y = YEAR OF ASSEMBLY  
 XX= ATMEL LOT NUMBER TO COORESPOND  
 WITH TRACE CODE LOG BOOK  
 (e.g. XX = AA, AB, AC,... AX, AY AZ)  
 Y = SEAL YEAR

6: 2006	0: 2010
7: 2007	1: 2011
8: 2008	2: 2012
9: 2009	3: 2013

## AT25160B-CUL

Top Mark

```

|---|---|---|---|
  5   A   B   U
|---|---|---|---|
  B   Y   M   X   X
|---|---|---|---|
  * <-- PIN 1 INDICATOR

```

B = Country of Origin  
 Y = One Digit Year Code  
 M = One Digit Month Code  
 XX= TRACE CODE (ATMEL LOT NUMBER TO  
 COORESPOND WITH TRACE CODE LOG BOOK)  
 (e.g. XX = AA, AB, AC,... YZ, ZZ)

Y = ONE DIGIT YEAR CODE	M = SEAL MONTH
4: 2004	7: 2007
5: 2005	8: 2008
6: 2006	9: 2009
	(USE ALPHA DESIGNATOR A-L)
	A = JANUARY
	B = FEBRUARY
	" " " " " " " " " "
	J = OCTOBER
	K = NOVEMBER
	L = DECEMBER

## 8. Ordering Codes

### AT25080B Ordering Information

Ordering Code	Voltage	Package	Operation Range
AT25080B-SSHL-B <sup>(1)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8S1	Lead-free/Halogen-free/ Industrial Temperature (–40 to 85°C)
AT25080B-SSHL-T <sup>(2)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8S1	
AT25080B-XHL-B <sup>(1)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8X	
AT25080B-XHL-T <sup>(2)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8X	
AT25080B-MAHL-T <sup>(2)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8MA2	
AT25080B-MEHL-T <sup>(2)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8ME1	
AT25080B-CUL-T <sup>(2)</sup> (SnAgCu Ball Finish)	1.8V to 5.5V	8U3-1	
AT25080B-WWU11L <sup>(3)</sup>	1.8V to 5.5V	Die Sale	Industrial Temperature (–40 to 85°C)

- Note:
1. Bulk delivery in tubes (SOIC and TSSOP 100/tube)
  2. Tape and reel delivery (SOIC 4k/reel. TSSOP, UDFN, XDFN and VFBGA 5k/reel)
  3. Contact Atmel Sales for Wafer sales

Package Type	
<b>8S1</b>	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)
<b>8X</b>	8-lead, 4.4 mm Body, Plastic Thin Shrink Small Outline Package (TSSOP)
<b>8MA2</b>	8-lead, 2.00 mm x 3.00 mm Body, 0.50 mm Pitch, Ultra Thin, Dual No Lead Package (UDFN)
<b>8ME1</b>	8-lead (1.80 mm x 2.20 mm Body) Extra Thin DFN (XDFN)
<b>8U3-1</b>	8-ball, die Ball Grid Array Package (VFBGA)

**AT25160B Ordering Information**

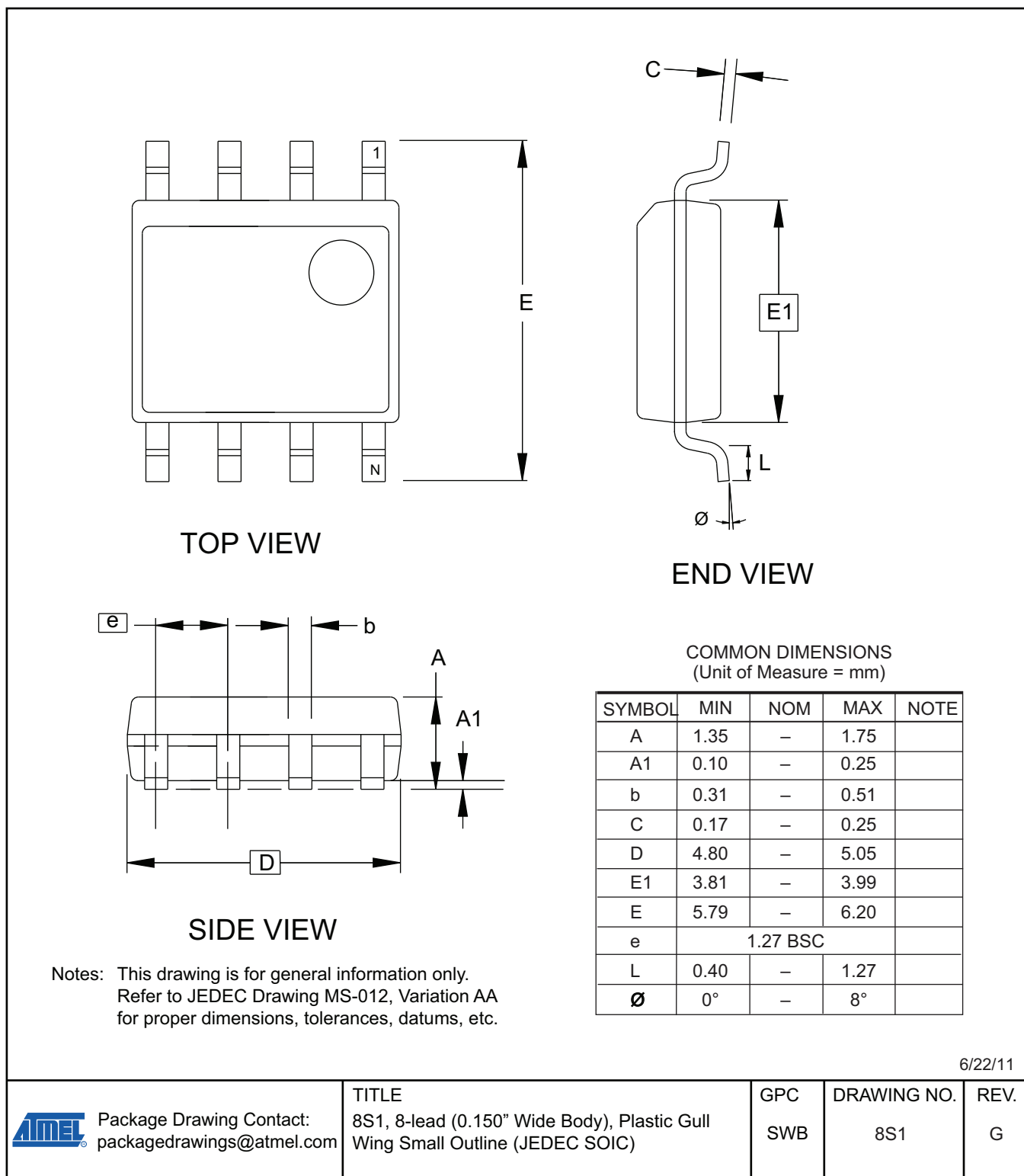
Ordering Code	Voltage	Package	Operation Range
AT25160B-SSHL-B <sup>(1)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8S1	Lead-free/Halogen-free/ Industrial Temperature (–40 to 85°C)
AT25160B-SSHL-T <sup>(2)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8S1	
AT25160B-XHL-B <sup>(1)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8X	
AT25160B-XHL-T <sup>(2)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8X	
AT25160B-MAHL-T <sup>(2)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8MA2	
AT25160B-MEHL-T <sup>(2)</sup> (NiPdAu Lead Finish)	1.8V to 5.5V	8ME1	
AT25160B-CUL-T <sup>(2)</sup> (SnAgCu Ball Finish)	1.8V to 5.5V	8U3-1	
AT25160B-WWU11L <sup>(3)</sup>	1.8V to 5.5V	Die Sale	Industrial Temperature (–40 to 85°C)

- Note:
1. Bulk delivery in tubes (SOIC and TSSOP 100/tube)
  2. Tape and reel delivery (SOIC 4k/reel. TSSOP, UDFN, XDFN and VFBGA 5k/reel)
  3. Contact Atmel Sales for Wafer sales

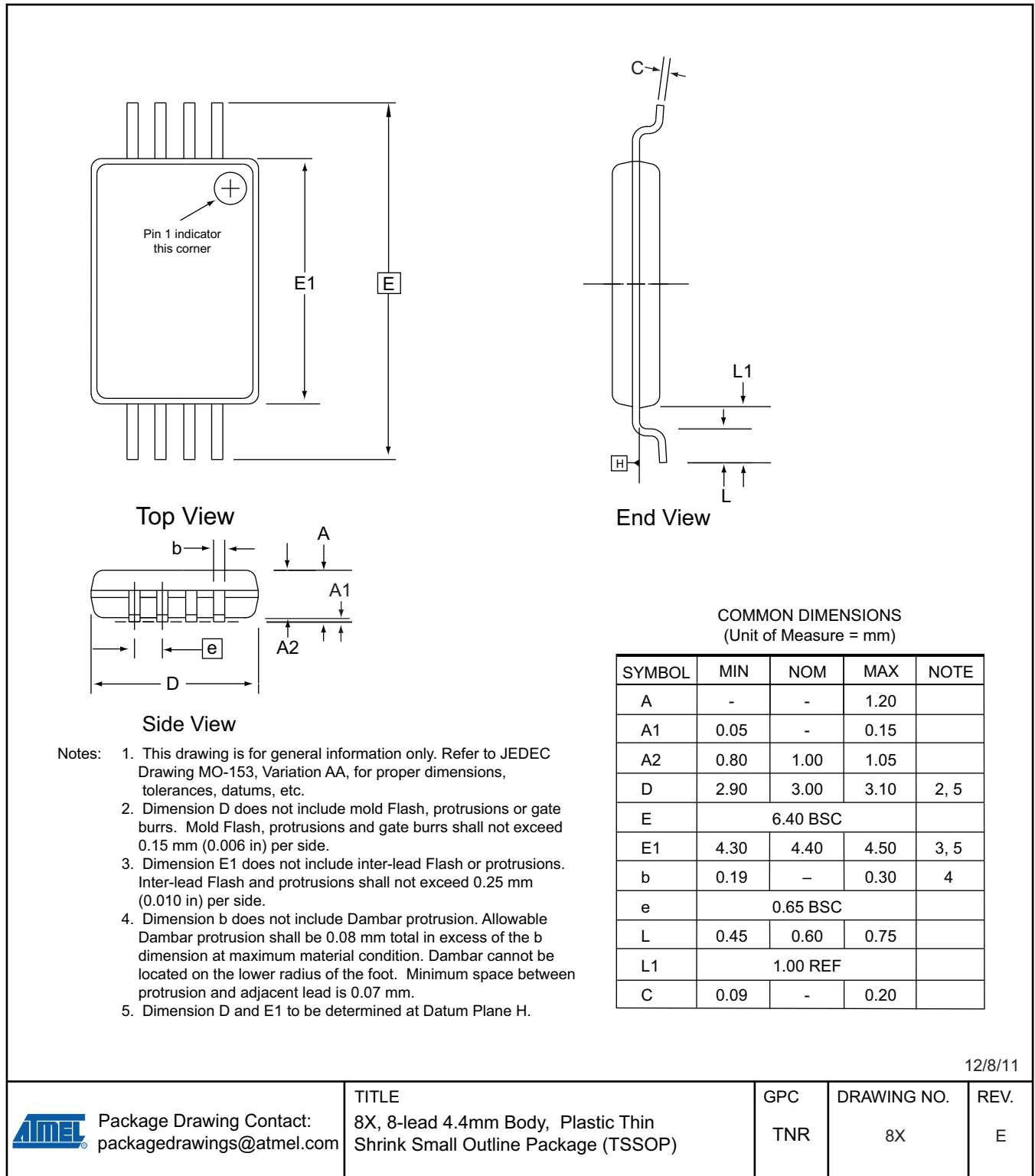
Package Type	
<b>8S1</b>	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)
<b>8X</b>	8-lead, 4.4 mm Body, Plastic Thin Shrink Small Outline Package (TSSOP)
<b>8MA2</b>	8-lead, 2.00 mm x 3.00 mm Body, 0.50 mm Pitch, Ultra Thin, Dual No Lead Package (UDFN)
<b>8ME1</b>	8-lead (1.80 mm x 2.20 mm Body) Extra Thin DFN (XDFN)
<b>8U3-1</b>	8-ball, die Ball Grid Array Package (VFBGA)

## 9. Packaging Information

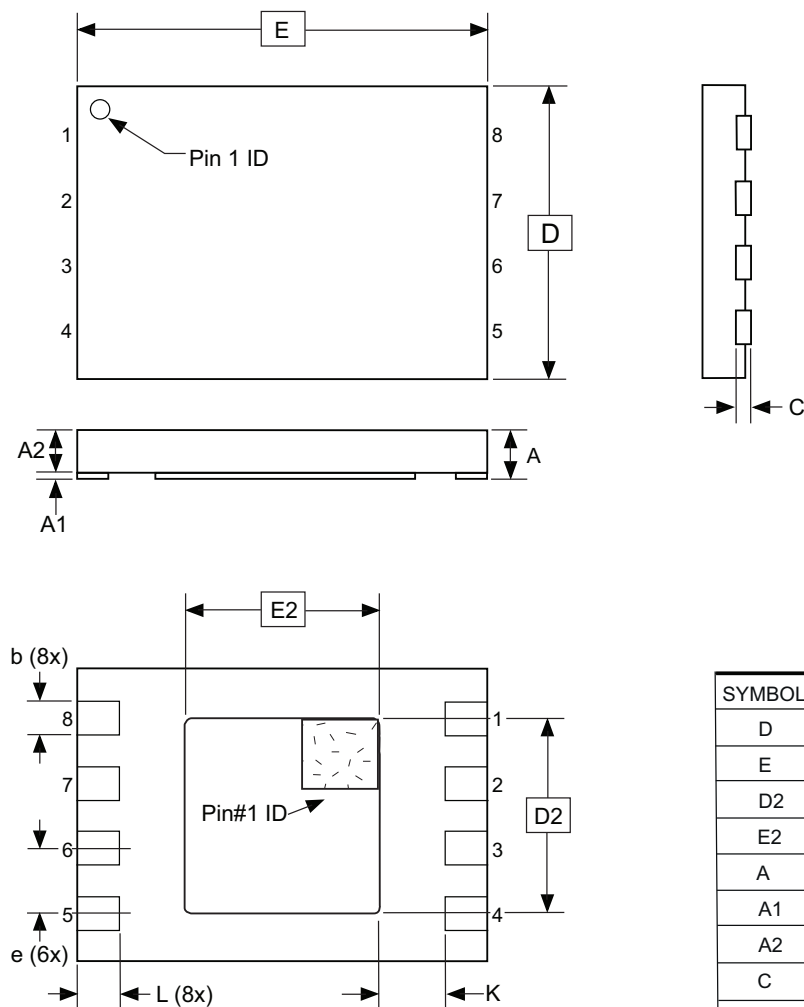
### 8S1 – JEDEC SOIC



8X – TSSOP



## 8MA2 - UDFN



COMMON DIMENSIONS  
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
D	2.00 BSC			
E	3.00 BSC			
D2	1.40	1.50	1.60	
E2	1.20	1.30	1.40	
A	0.50	0.55	0.60	
A1	0.0	0.02	0.05	
A2	—	—	0.55	
C	0.152 REF			
L	0.30	0.35	0.40	
e	0.50 BSC			
b	0.18	0.25	0.30	3
K	0.20	—	—	

- Notes: 1. This drawing is for general information only. Refer to JEDEC Drawing MO-229, for proper dimensions, tolerances, datums, etc.  
 2. The terminal #1 ID is a laser-marked feature.  
 3. Dimension b applies to metallized terminal and is measured between 0.15 mm and 0.30 mm from the terminal tip. If the terminal has the optional radius on the other end of the terminal, the dimension should not be measured in that radius area.

7/15/11



**Package Drawing Contact:**  
packagedrawings@atmel.com

**TITLE**  
8MA2, 8-pad, 2 x 3 x 0.6 mm Body, Thermally  
Enhanced Plastic Ultra Thin Dual Flat No  
Lead Package (UDFN)

**GPC**

YNZ

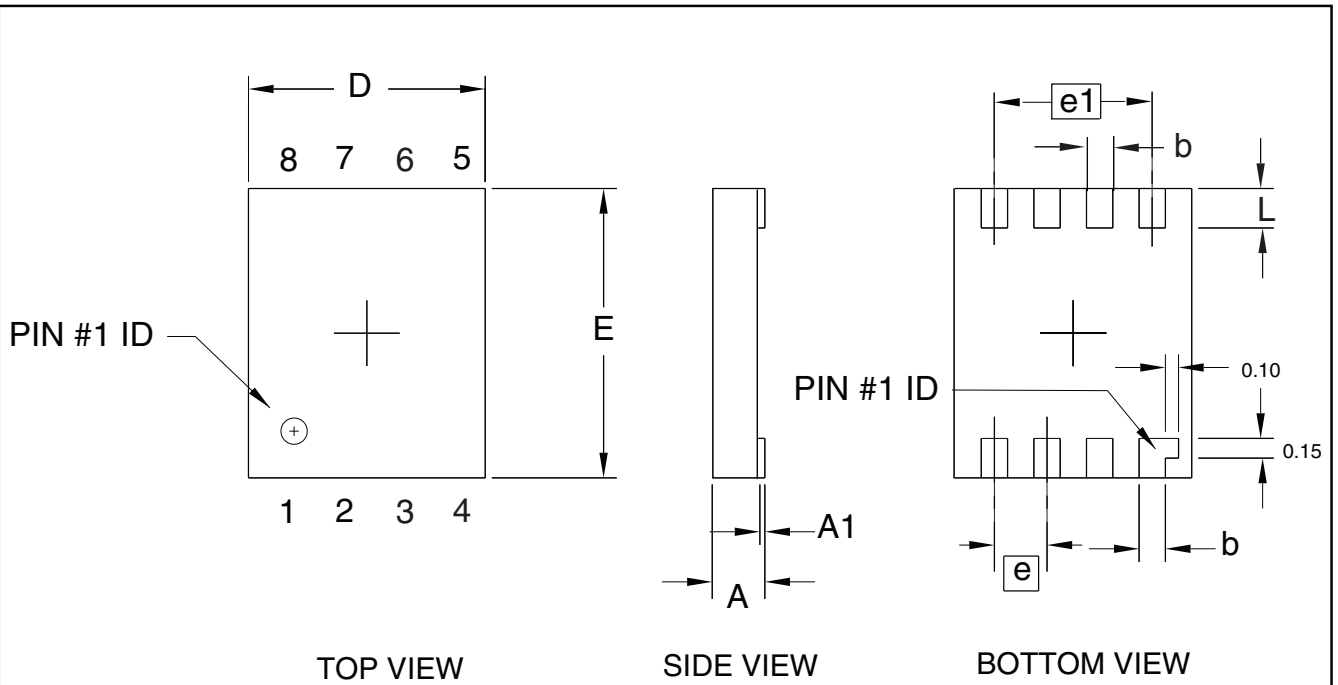
**DRAWING NO.**

8MA2

**REV.**

B


8ME1 - XDFN



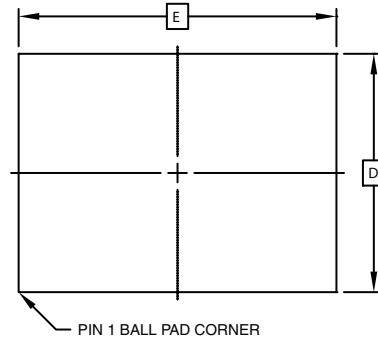
COMMON DIMENSIONS  
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	-	-	0.40	
A1	0.00	-	0.05	
D	1.70	1.80	1.90	
E	2.10	2.20	2.30	
b	0.15	0.20	0.25	
e	0.40 TYP			
e1	1.20 REF			
L	0.26	0.30	0.35	

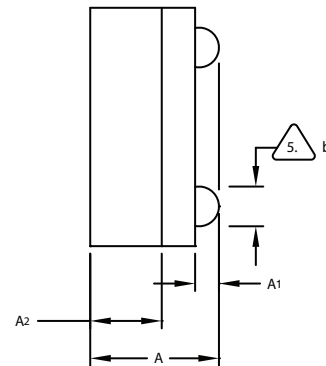
8/3/09

 <b>Package Drawing Contact:</b> packagedrawings@atmel.com	<b>TITLE</b> 8ME1, 8-lead (1.80x2.20mm Body) Extra Thin DFN (XDFN)	<b>GPC</b>	<b>DRAWING NO.</b>	<b>REV.</b>
		DTP	8ME1	A

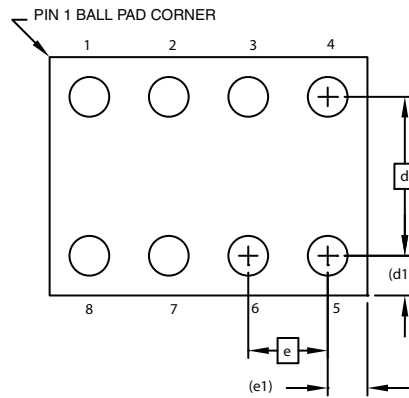
## 8U3-1 - VFBGA



TOP VIEW



SIDE VIEW



BOTTOM VIEW  
8 SOLDER BALLS

**Notes:**

1. This drawing is for general information only.
2. Dimension 'b' is measured at maximum solder ball diameter.
3. Solder ball composition shall be 95.5Sn-4.0Ag-.5Cu.

COMMON DIMENSIONS  
(Unit of Measure - mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	0.73	0.79	0.85	
A1	0.09	0.14	0.19	
A2	0.40	0.45	0.50	
b	0.20	0.25	0.30	2
D	1.50 BSC			
E	2.0 BSC			
e	0.50 BSC			
e1	0.25 REF			
d	1.00 BSC			
d1	0.25 REF			

07/14/10



**Package Drawing Contact:**  
packagedrawings@atmel.com

**TITLE**  
8U3-1, 8-ball, 1.50 x 2.00 mm Body,  
0.50 pitch, VFBGA Package (dBG2)

**GPC**  
GXU

**DRAWING NO.**  
8U3-1

**REV.**  
D



## 10. Revision History

Doc. Rev.	Date	Comments
5228E	03/2012	Update 8A2 to 8X and 8S1, 8MA2, 8U3-1 package drawings
5228D	04/2010	Update Ordering Code Detail and Ordering Information
5228C	08/2009	Change Catalog Scheme Add Marking Details
5228B	07/2008	Change 'Endurance' parameter on page 6
5228A	09/2007	Initial document release



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- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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